

HSF

NOTES:

Current Rating: 2.0AMP
Contact Resistance: 20mΩ Max
Withstand Voltage: 500V AC/DC
Insulation Resistance: 1000MΩ Min
Operation Temperature: -40℃ to +105℃

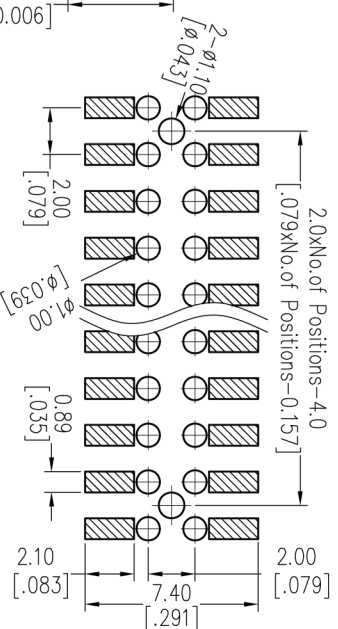
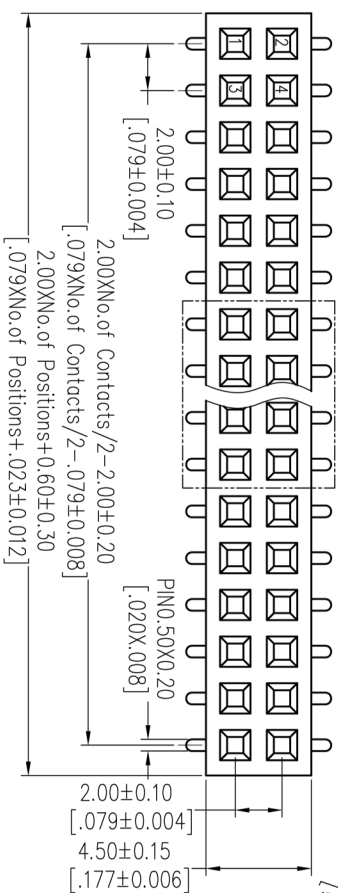
Contact Material: Phosphor Bronze
Contact plating: Au Or Sn over Ni
Insulator Material: PA9T+30%G.F UL94V-0

Ordering Information

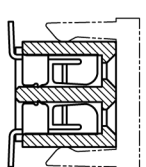
2243-2 XX M XX CUN T X

- No. of Pins per Row: 02-40Pin
- Contact Plating:
G0=Gold Flash
G3=10μ"Gold
G4=15μ"Gold
G5=30μ"Gold
S0=Gold Flash/Tin
S3=10μ"Gold/Tin
S4=15μ"Gold/Tin
S5=30μ"Gold/Tin
SN=Tin
SM=Mate Tin
- Packing:
T=Tube
P=Tube+CAP
R=TubeReel+CAP
- Series No.
1=Type 1
2=Type 2

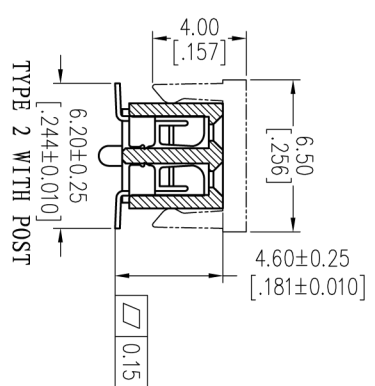
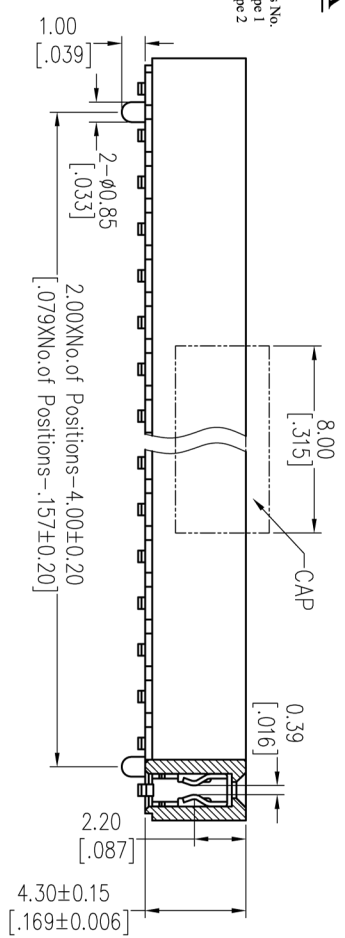
Item	Pitch	Mating
Standard	2.00	1215/1220
Alternate		



Recommended P.C.B Layout(Top Side)
(PCB BOARD TOLERANCE±0.05)



TYPE 1 W/O POST



TITLE	PART NO.
TYPE 1	2243-2XXMXXCUNT1
TYPE 2	2243-2XXMXXCUNT2

				OPERATION	DRAW	DATE	SCALE	FIT	PART NO.	SEE TABLE	
				XX	JYHuang	2012/07/14	UNIT	mm			
				XX	CHECK	DATE	SIZE	A4	TITLE:		
				XXX	±0.15		SHEET	1/1	FH2.00 DUAL ROW 180° SMT		
				Angle	± 3°	APPROVE	DATE	PROJ.	H=4.3 W=4.5		
REV	DATE	MODIFICATION DESCRIPTION			CHANGE	DIM	TOL	Customer NO.			
1		2	3	4	5	6	7	8	9	10	

上海回峰电子科技有限公司
Shanghai Hui Feng Electronic Technology Co., Ltd.

电话: 021-67150229
传真: 021-67150251
企业邮箱: huiheng_dzkj@163.com
公司网站: www.huiheng-china.com